Hybrid 8j432 Traveler

July 17, 2000

1 Connectivity

Repairs on shorts:
Fixes for opens:

2 Chips

The following chips were assembled on this hybrid (in the order that the chips get read out):
Hybrid 8J432 has die: 242-103 244-017 244-044 244-059 168-082 168-083 168-086 168-087

3 Data Analysis Summary

The following summarizes the findings of the Burn-in data analysis program. The first chip in the readout name is numbered 0.

```
% Hybrid 8j432 classification info. Created 12:01:32 06/30/00

Hybrid 8j432 quality: bad
Chip classification: good fair bad good good fair good fair
Bad channels (chip-channel): 1-1 1-19 2-65 2-120 2-121 5-29 7-112
Bad cells: none
Random bad capacitors (chip-cell-channel): 7-35-79 7-38-111 7-40-9
Channels at pedestal needed for DCMS: 32.6 30.4 29.7 31.6 33.6 32.6 34.2 34.6
```

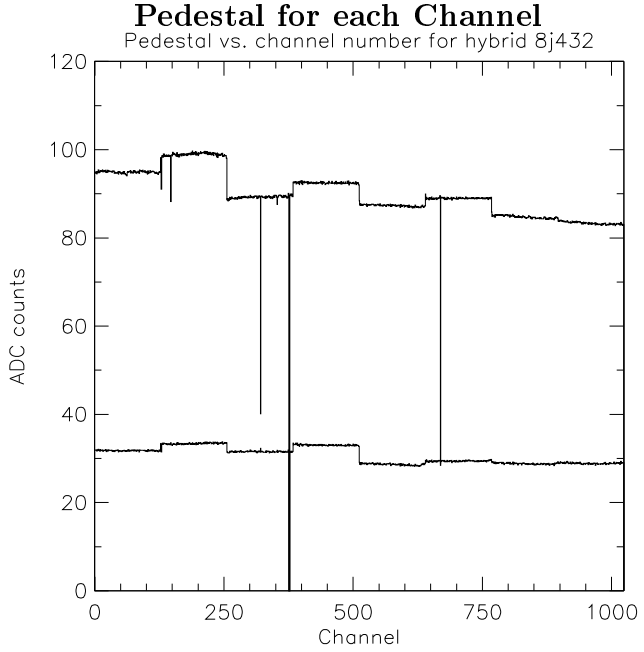
4 Comments

HV tested.

5 Pedestal

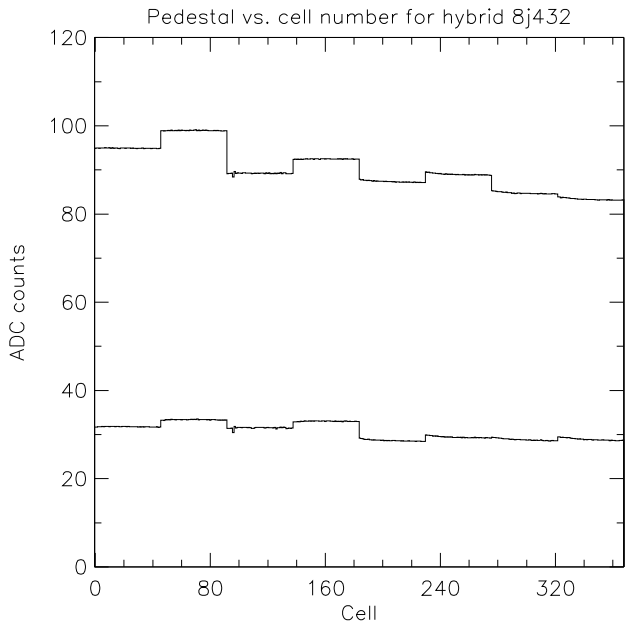
The following plot shows the pedestals vs. channel number with and without charge injection:

Pedestal for each Channel



The following plot shows the average pedestal vs. pipeline cell ID with and without charge injection. The x-axis is cell ID offset by 46 for each chip. Thus cell ID 5 for chip 1 is at x=5, chip 2 at x=51, chip 3 at x=97, etc.

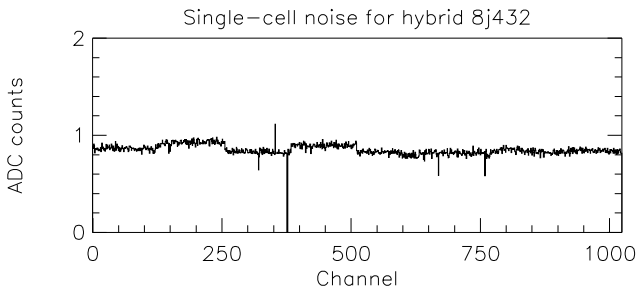
Pedestal vs. Pipeline Cell ID

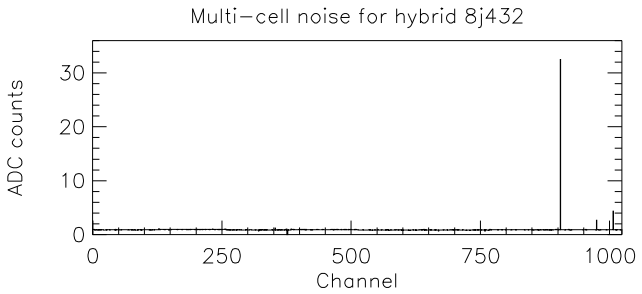


6 Noise

The following plots show the single-cell and multi-cell RMS noise:

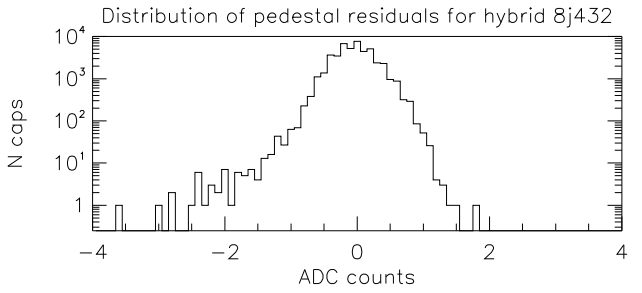
RMS Noise

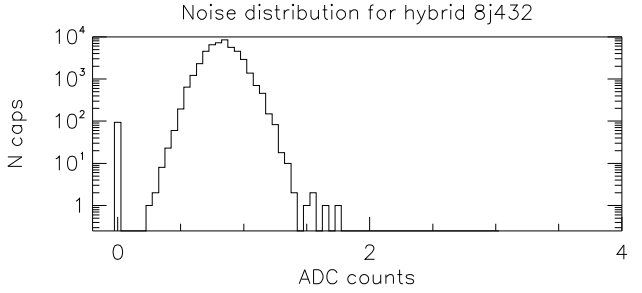




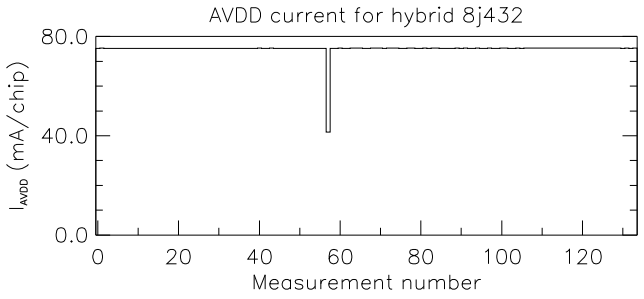
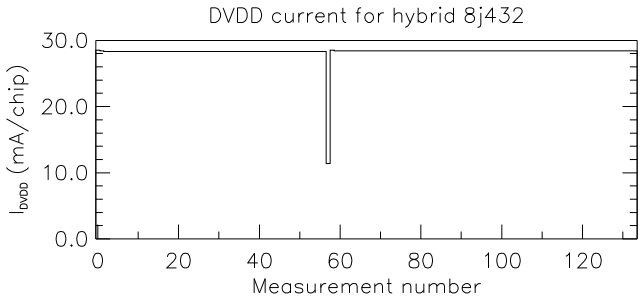
The following are histograms of the pedestal of each pipeline capacitor relative to the chip average (top); and the RMS noise of each capacitor (bottom):

Distribution of Pedestals and Noise





7 Currents

The following plots show the supply currents per chip as a function of measurment number. Currents are measured approximately every 10 minutes:

Supply Currents During Burn-in